

2SK1620(L), 2SK1620(S)

Silicon N Channel MOS FET

REJ03G0957-0200

(Previous: ADE-208-1298)

Rev.2.00 Sep 07, 2005

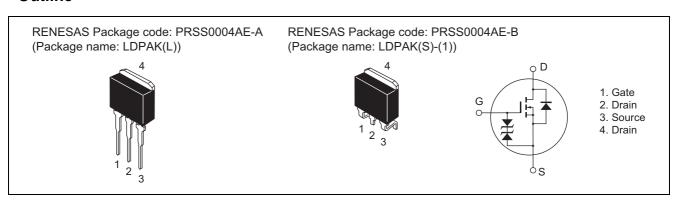
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator, DC-DC converter and motor driver

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	150	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	10	Α
Drain peak current	I _{D(pulse)} *1	40	Α
Body to drain diode reverse drain current	I _{DR}	10	Α
Channel dissipation	Pch ^{*2}	50	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at $T_C = 25$ °C

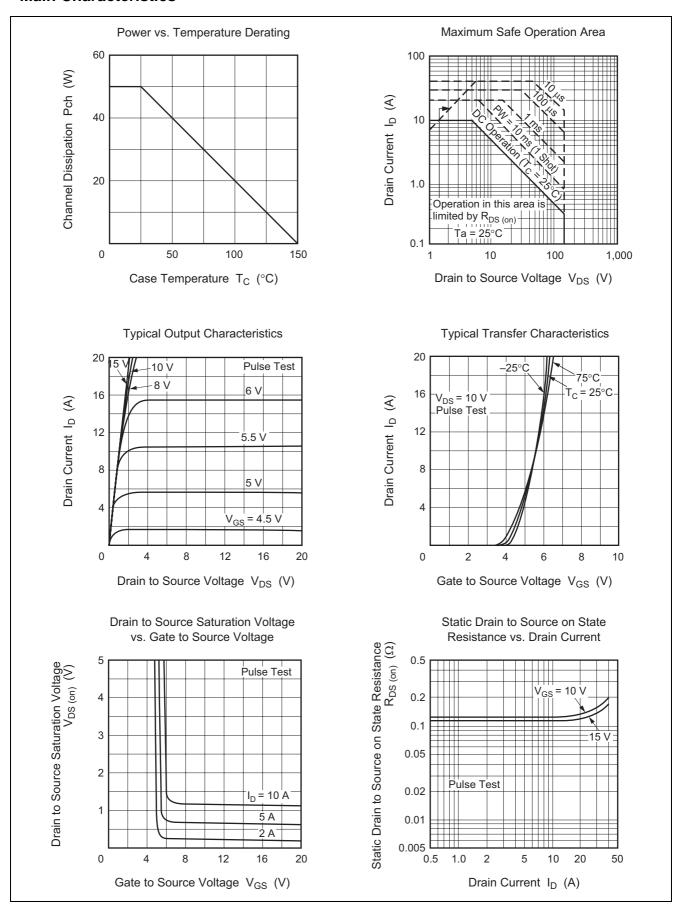
Electrical Characteristics

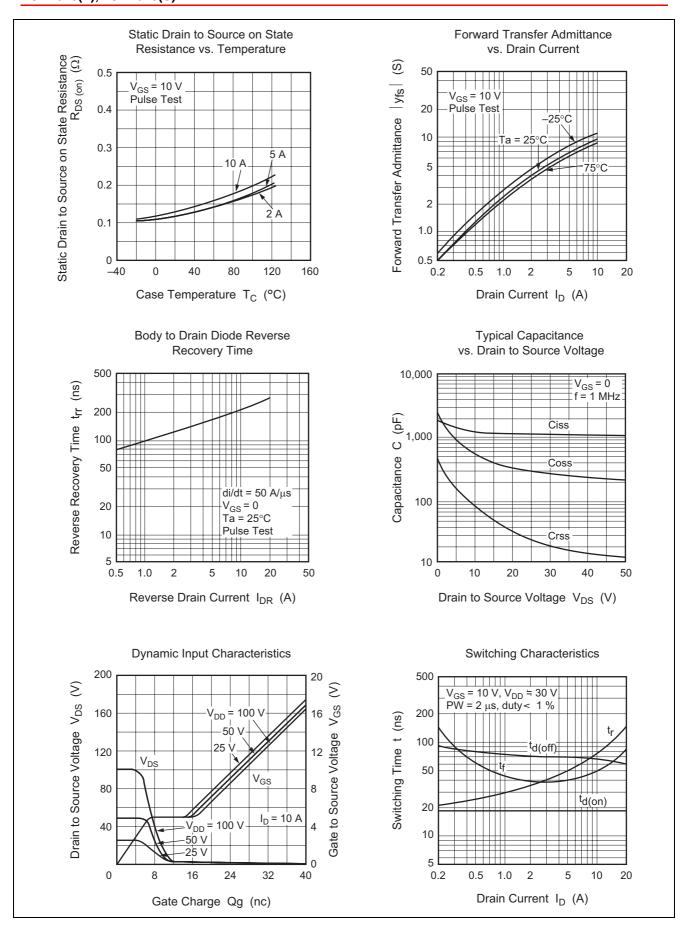
 $(Ta = 25^{\circ}C)$

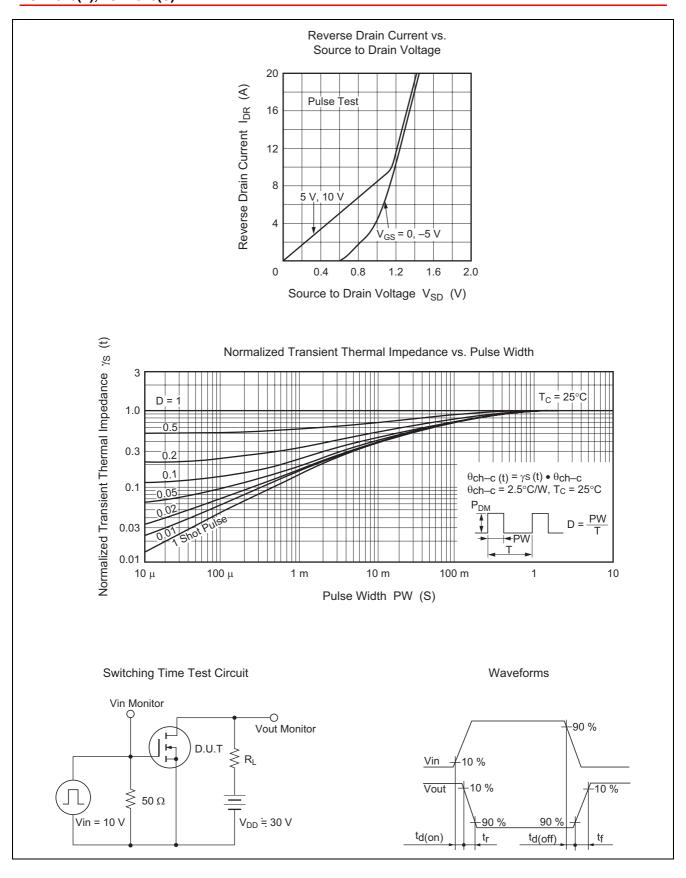
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	150	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I_{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	-	_	250	μΑ	$V_{DS} = 120 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	2.0	_	4.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	R _{DS(on)}	_	0.12	0.15	Ω	$I_D = 5 \text{ A}, V_{GS} = 10 \text{ V}^{*3}$
Forward transfer admittance	y _{fs}	4.0	7.0	_	S	$I_D = 5 \text{ A}, V_{DS} = 10 \text{ V}^{*3}$
Input capacitance	Ciss	_	1200	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	550	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	85	_	pF	
Turn-on delay time	t _{d(on)}	_	20	_	ns	$I_D = 5 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time	t _r	_	50	_	ns	$R_L = 6 \Omega$
Turn-off delay time	$t_{d(off)}$	_	70	_	ns	
Fall time	t _f	_	40	_	ns	
Body to drain diode forward voltage	V_{DF}	_	1.2	_	V	$I_F = 10 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t _{rr}	_	220	_	ns	$I_F = 10 \text{ A}, V_{GS} = 0,$ $di_F/dt = 50 \text{ A}/\mu\text{s}$

Note: 3. Pulse test

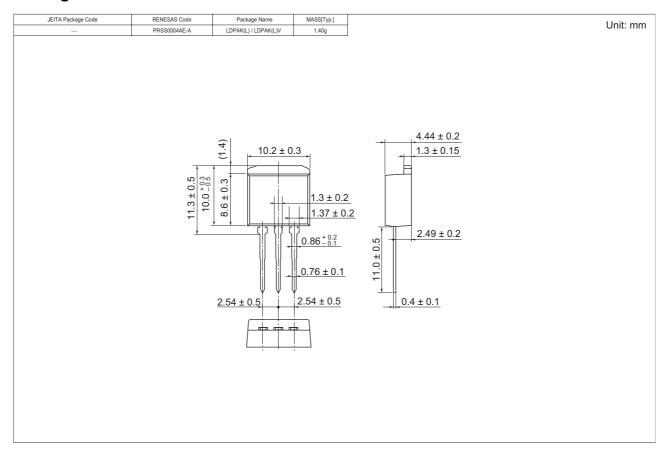
Main Characteristics

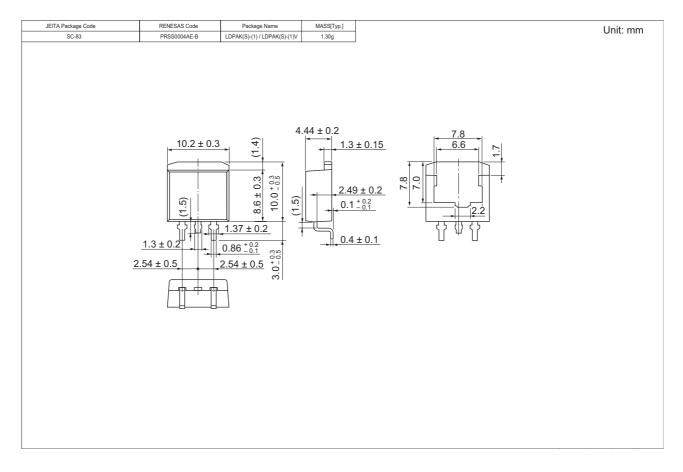






Package Dimensions





Ordering Information

Part Name	Quantity	Shipping Container
2SK1620L-E	500 pcs	Box (Sack)
2SK1620STL-E	1000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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